



Climate
for Culture

Numerical Modelling of the Damage Potential of Indoor Climate Variations to a Historic Wooden Cabinet

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Where innovation starts

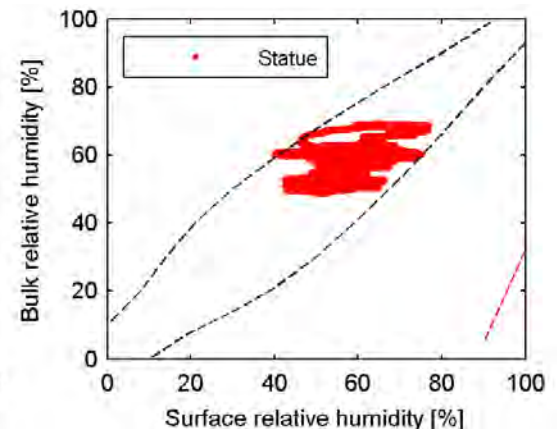
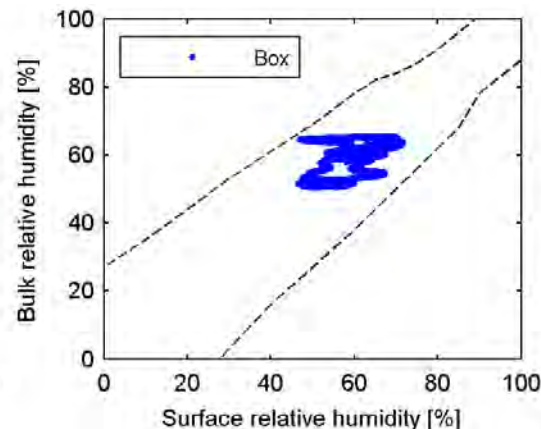
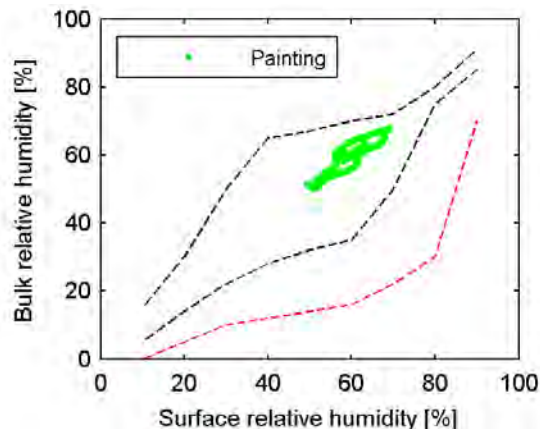
Introduction

Museum objects

- Risks of biological, chemical and mechanical degradation due to wrong indoor climate conditions

➔ Prediction of mechanical stress related to climate variations

- Analysis of hygroscopic and mechanical behaviour of objects
- Definition of tolerable fluctuations of relative humidity



Sources:

Panel painting: Mecklenburg et al. (1998)

Lacquer Box: Bratasz et al. (2009)

Wooden Statue: Kozłowski (2007)

Graphical representation: Martens (2011)

Case study

Van Mekerens Cabinet

- Situated in Grand Salon, Amerongen Castle, The Netherlands
- Created by Jan van Mekerens around 1690-1710

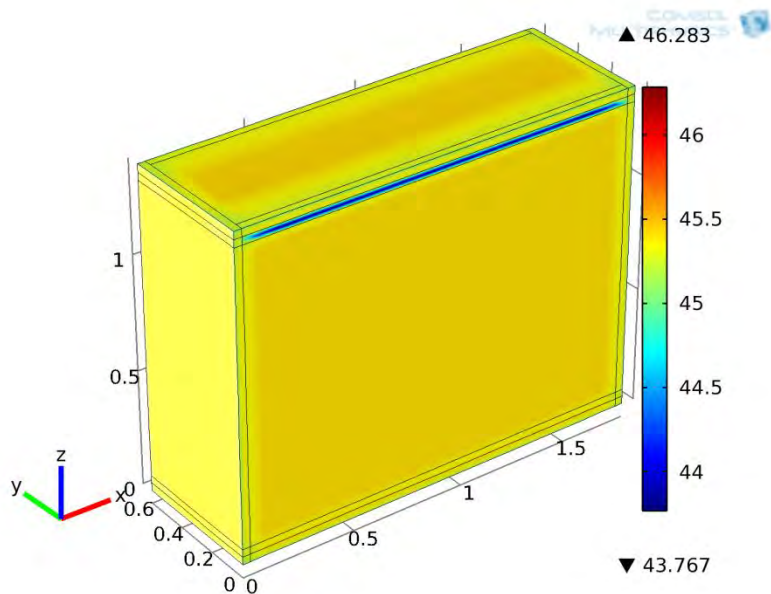


Objectives

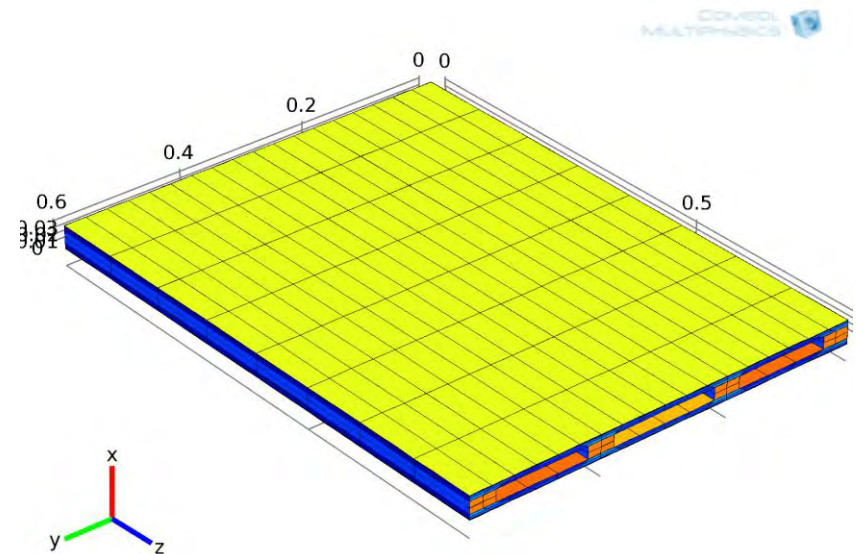
- To analyse the response time of a door panel to a sudden relative humidity increase
 - To analyse the microclimate conditions around the cabinet as a results of the indoor climate conditions in the Grand Salon
 - To predict deformation of a door panel due to climate variations
- ➔ Validation with **on-site measurements**

COMSOL modelling

- Heat transfer in solids and fluids module
- Structural mechanics module



3D model of cabinet



3D model of door panel

COMSOL modelling

- Heat and moisture transport

$$\rho c_p \frac{\partial T}{\partial t} = \nabla(k \nabla T)$$

$$\frac{\partial P_v}{\partial t} = \nabla(D(P_v) \nabla P_v)$$

ρ	=	density [kg/m ³]
c_p	=	specific heat capacity [J/kgK]
T	=	temperature [°C]
K	=	thermal conductivity [W/mK]
P_v	=	vapour pressure [Pa]
$D(P)$	=	moisture diffusion coefficient [m ² /s]

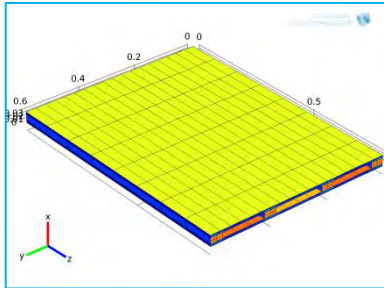
COMSOL modelling

■ Stress and strain

$$\begin{pmatrix} \varepsilon_x \\ \varepsilon_y \\ \gamma_{xy} \end{pmatrix} = \begin{pmatrix} \frac{1}{E_x} & -\frac{\nu_{xy}}{E_y} & 0 \\ -\frac{\nu_{yx}}{E_x} & \frac{1}{E_y} & 0 \\ 0 & 0 & \frac{1}{G_{xy}} \end{pmatrix} \begin{pmatrix} \sigma_x \\ \sigma_y \\ \tau_{xy} \end{pmatrix} + \begin{pmatrix} \alpha_x \\ \alpha_y \\ 0 \end{pmatrix} \Delta\theta + \begin{pmatrix} \kappa_x \\ \kappa_y \\ 0 \end{pmatrix} \Delta w$$

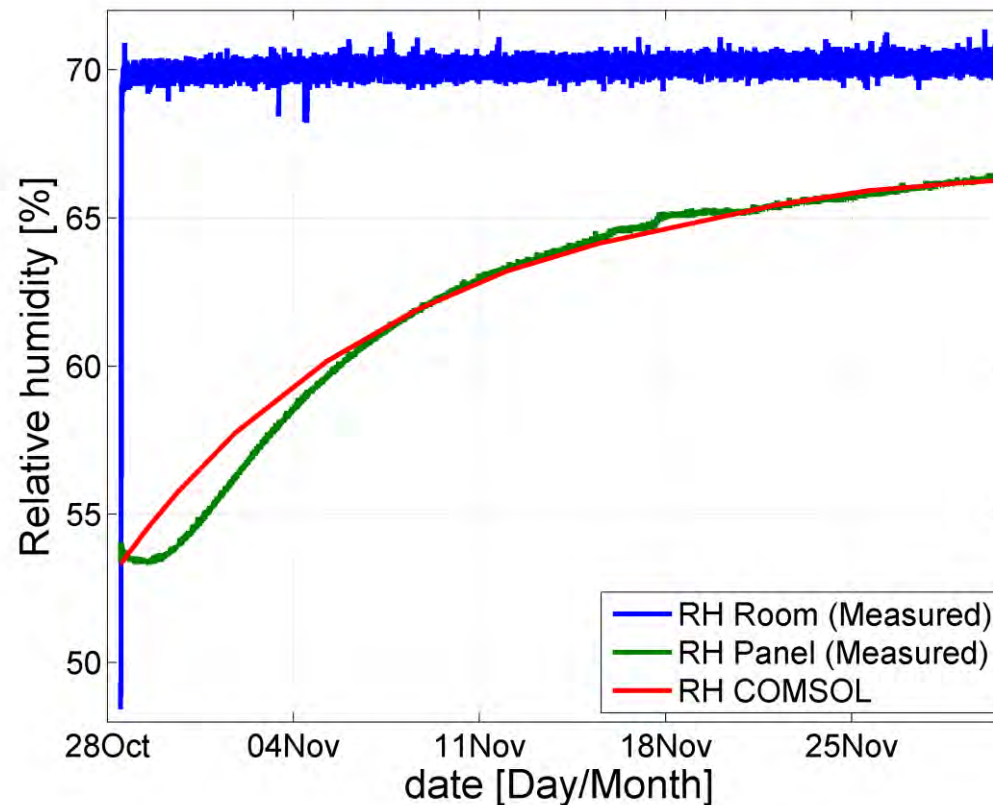
$\varepsilon_x, \varepsilon_y$	=	normal strain components [-]
γ_{xy}	=	shear strain component associated with two axis [-]
ν_{xy}, ν_{yx}	=	Poisson's ratio [-]
E_x, E_y	=	Young's moduli [N/m ²]
G_{xy}	=	shear modulus [N/m ²]
α_x, α_y	=	linear thermal expansivity [m/mK]
θ	=	temperature [°C]
κ_x, κ_y	=	linear deformation due to changes in moisture content [m/m(kg/m ³)]
w	=	moisture content [kg/m ³]

Response time

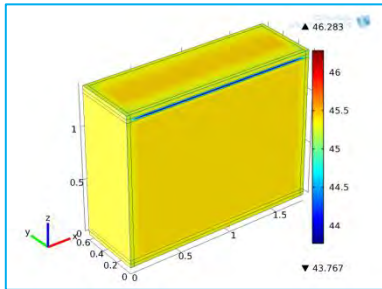


Test chamber experiment

- Sudden relative humidity increase from 50% to 70%
- Temperature is maintained constant at 20°C

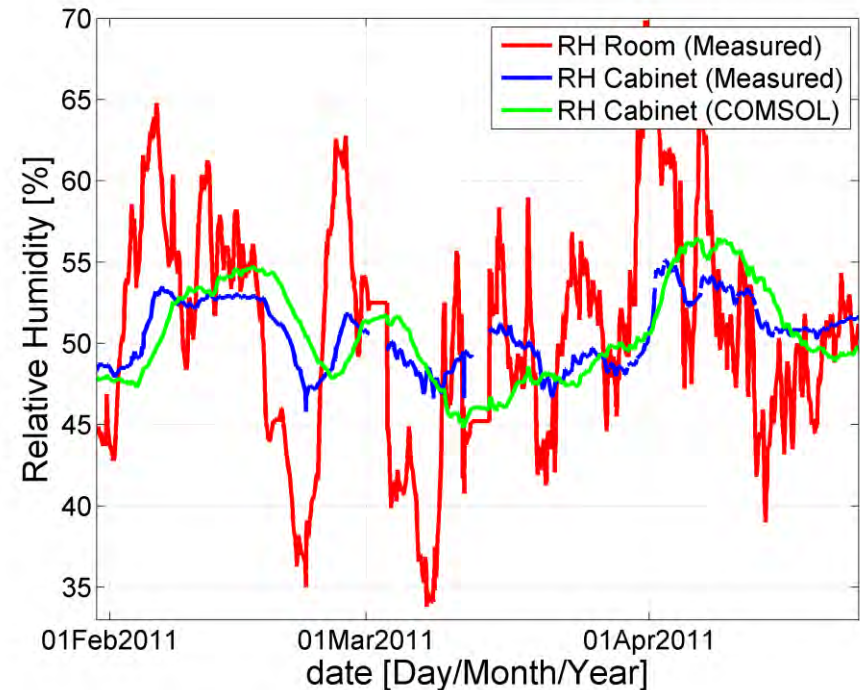
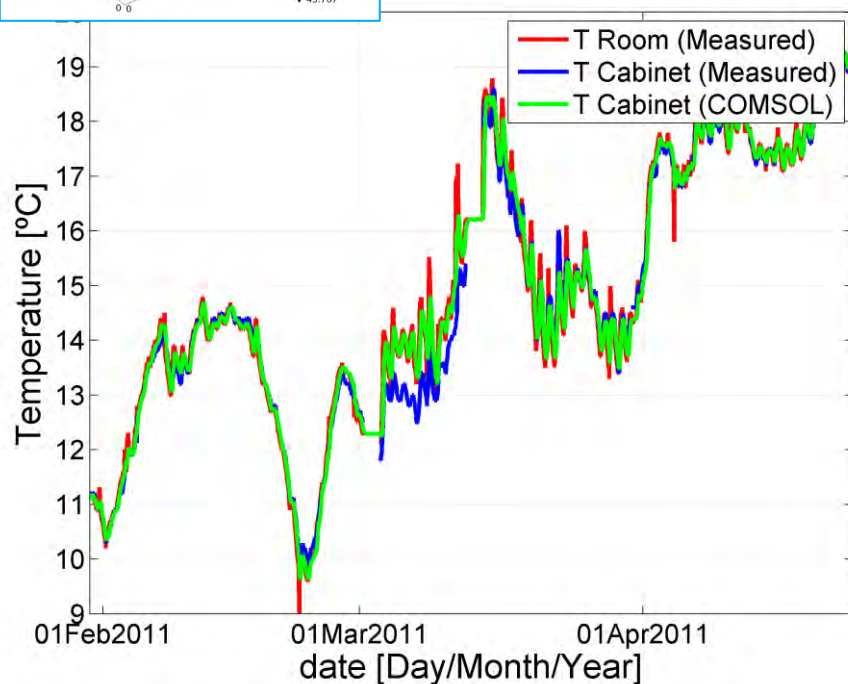


Microclimate conditions



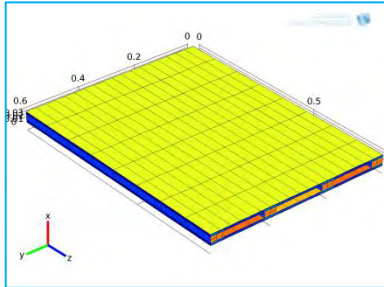
On-site measurements of temperature and relative humidity in Grand Salon and inside cabinet

- Comparison between measured and simulated microclimate conditions in COMSOL

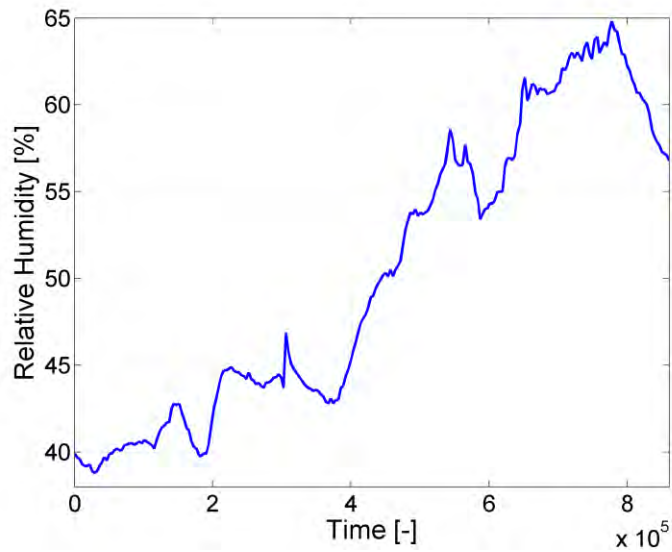


Deformation

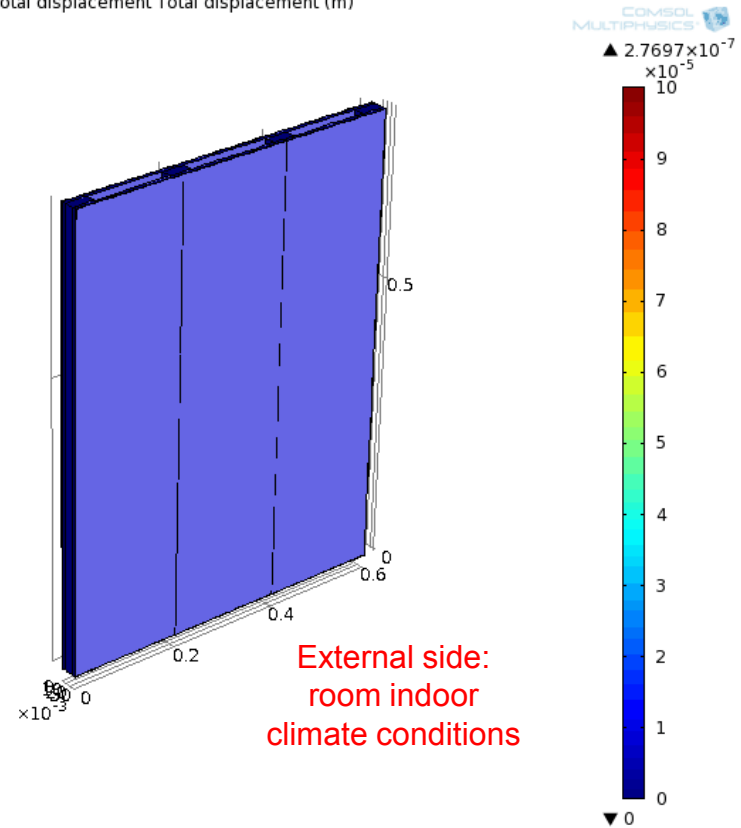
Predicted displacement during 10 days



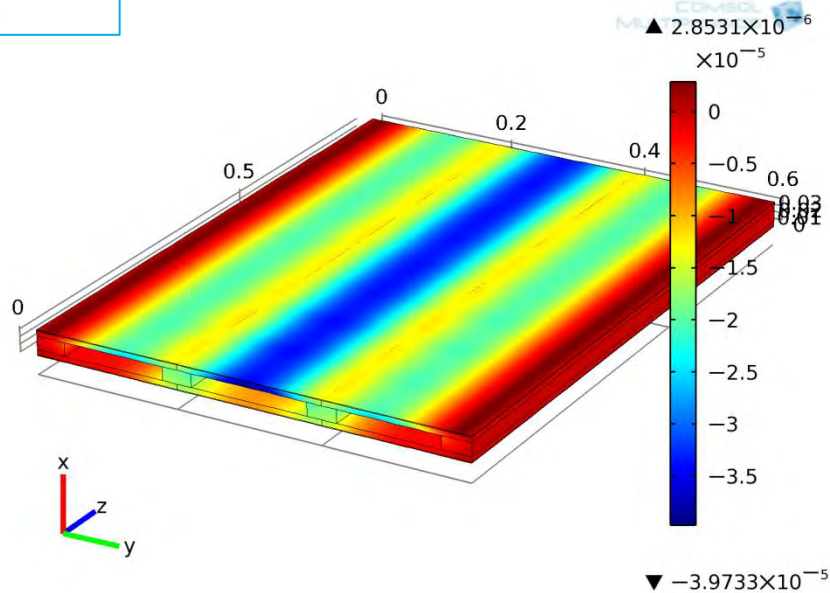
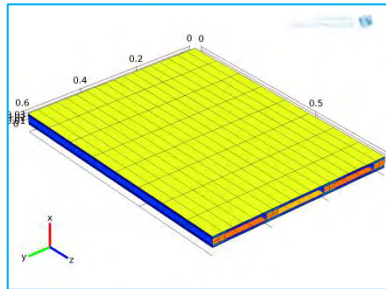
Time=0 Surface: Total displacement Total displacement (m)



Internal side:
microclimate
conditions
cabinet



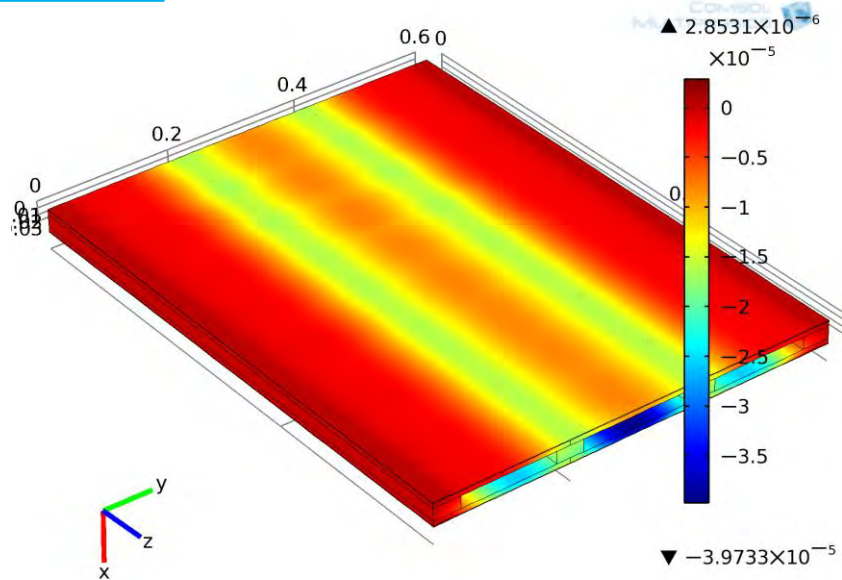
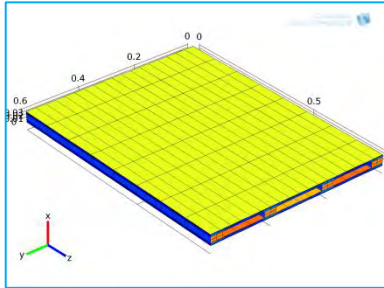
Deformation



Predicted deformation at external side
 $t = 1000$



Deformation



Predicted deformation at internal side
 $t=1000$

Conclusions

- **Response time of door panel is adequately predicted**
- **Modelling of microclimate conditions requires improvement**
- **Agreement is found between predicted deformation and visible damage**
- **More detailed measurements of hygroscopic and mechanical properties of the various wood types in the cabinet are necessary to calculate stress and strain in the cabinet as a result of climate variations**

Thank you for your attention



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